



3.3V CMOS 16-BIT REGISTERED TRANSCEIVER WITH 3-STATE OUTPUTS, 5 VOLT TOLERANT I/O, BUS-HOLD

IDT74LVCH16543A

FEATURES:

- Typical $t_{sk(0)}$ (Output Skew) < 250ps
- ESD > 2000V per MIL-STD-883, Method 3015; > 200V using machine model (C = 200pF, R = 0)
- 0.635mm pitch SSOP, 0.50mm pitch TSSOP and 0.40mm pitch TVSOP packages
- Extended commercial range of -40°C to +85°C
- $V_{CC} = 3.3V \pm 0.3V$, Normal Range
- $V_{CC} = 2.7V$ to 3.6V, Extended Range
- CMOS power levels (0.4μW typ. static)
- All inputs, outputs and I/O are 5 Volt tolerant
- Supports hot insertion

Drive Features for LVCH16543A:

- High Output Drivers: ±24mA
- Reduced system switching noise

APPLICATIONS:

- 5V and 3.3V mixed voltage systems
- Data communication and telecommunication systems

DESCRIPTION

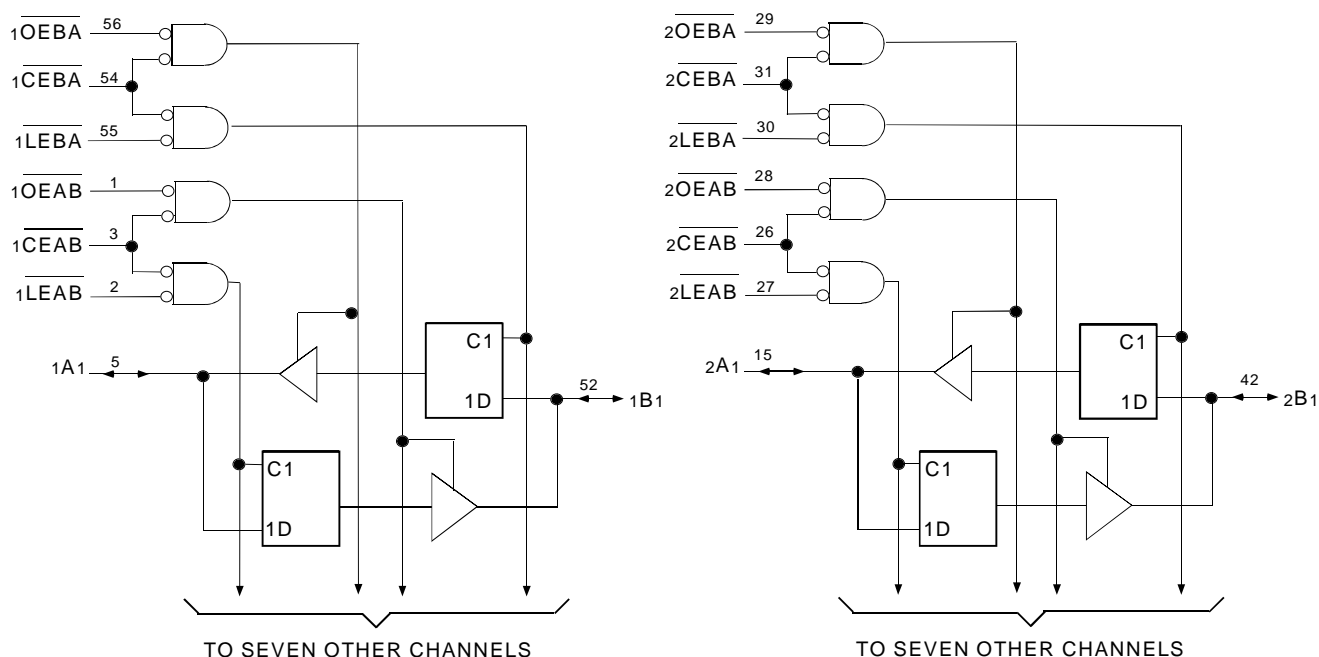
The LVCH16543A 16-bit registered transceiver is built using advanced dual metal CMOS technology. The LVCH16543A can be used as two 8-bit transceivers or one 16-bit transceiver. Separate latch-enable (\overline{LEAB} or \overline{LEBA}) and output-enable (\overline{OEAB} or \overline{OEBA}) inputs are provided for each register to permit independent control in either direction of data flow. The A-to-B enable (\overline{CEAB}) input must be low in order to enter data from the A port or to output data from the B port. \overline{LEAB} controls the latch function. When \overline{LEAB} is low, the A to B latches are transparent. A subsequent low-to-high transition of \overline{LEAB} puts the A latches in the storage mode. \overline{OEAB} performs output enable function on the B port. Data flow from the B port to the A port is similar but requires using \overline{CEBA} , \overline{LEBA} , and \overline{OEBA} inputs. Flow-through organization of signal pins simplifies layout. All inputs are designed with hysteresis for improved noise margin.

All pins of this 16-bit registered transceiver can be driven from either 3.3V or 5V devices. This feature allows the use of this device as a translator in a mixed 3.3V/5V supply system.

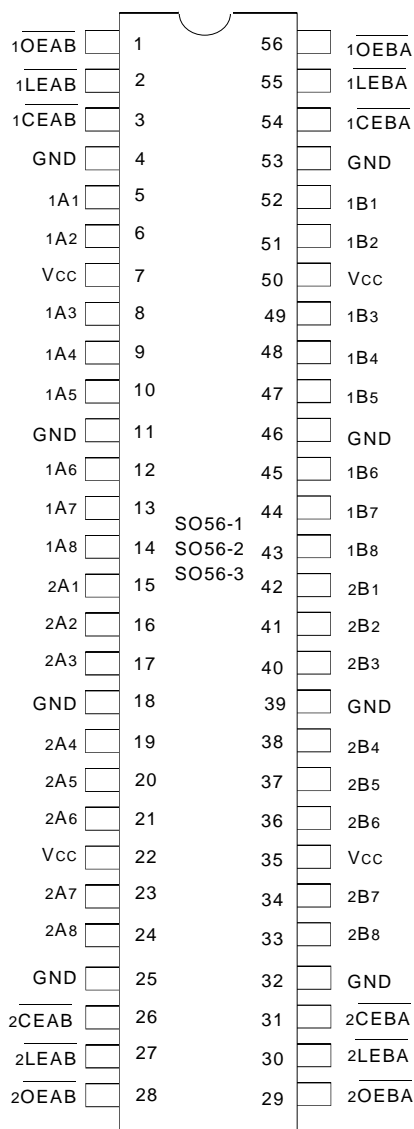
The LVCH16543A has been designed with a ±24mA output driver. This driver is capable of driving a moderate to heavy load while maintaining speed performance.

The LVCH16543A has "bus-hold" which retains the inputs' last state whenever the input goes to a high impedance. This prevents floating inputs and eliminates the need for pull-up/down resistors.

Functional Block Diagram



PIN CONFIGURATION



SSOP/TSSOP/TVSOP
TOP VIEW

PIN DESCRIPTION

Pin Names	Description
\overline{xOEAB}	A-to-B Output Enable Input (Active LOW)
\overline{xOEBA}	B-to-A Output Enable Input (Active LOW)
\overline{xCEAB}	A-to-B Enable Input (Active LOW)
\overline{xCEBA}	B-to-A Enable Input (Active LOW)
\overline{xLEAB}	A-to-B Latch Enable Input (Active LOW)
\overline{xLEBA}	B-to-A Latch Enable Input (Active LOW)
xAx	A-to-B Data Inputs or B-to-A 3-State Outputs ⁽¹⁾
xBx	B-to-A Data Inputs or A-to-B 3-State Outputs ⁽¹⁾

NOTE:

1. These pins have "Bus-hold". All other pins are standard inputs, outputs, or I/Os.

ABSOLUTE MAXIMUM RATINGS (1)

Symbol	Description	Max.	Unit
$V_{TERM}^{(2)}$	Terminal Voltage with Respect to GND	- 0.5 to +6.5	V
$V_{TERM}^{(3)}$	Terminal Voltage with Respect to GND	- 0.5 to +6.5	V
TSTG	Storage Temperature	- 65 to +150	°C
I_{OUT}	DC Output Current	- 50 to +50	mA
I_{IK} I_{OK}	Continuous Clamp Current, $V_I < 0$ or $V_O < 0$	- 50	mA
I_{CC} I_{SS}	Continuous Current through each V_{CC} or GND	± 100	mA

LVC Link

NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- V_{CC} terminals.
- All terminals except V_{CC} .

CAPACITANCE ($T_A = +25^\circ C$, $f = 1.0 MHz$)

Symbol	Parameter ⁽¹⁾	Conditions	Typ.	Max.	Unit
C_{IN}	Input Capacitance	$V_{IN} = 0V$	4.5	6	pF
C_{OUT}	Output Capacitance	$V_{OUT} = 0V$	6.5	8	pF
$C_{I/O}$	I/O Port Capacitance	$V_{IN} = 0V$	6.5	8	pF

LVC Link

NOTE:

- As applicable to the device type.

FUNCTION TABLE (each 8-bit section)^(1,2)

Inputs			Latch Status	Output Buffers
\overline{xCEAB}	\overline{xLEAB}	\overline{xOEAB}	xAx to xBx	xBx
H	X	X	Storing	High Z
X	X	H	Storing	High Z
L	L	L	Transparent	Current A Inputs
L	H	L	Storing	Previous ⁽³⁾ A Inputs
L	L	H	Transparent	High Z
L	H	H	Storing	High Z
X	H	X	Storing	Not Recommended

NOTES:

- H = HIGH Voltage Level
L = LOW Voltage Level
X = Don't Care
- A-to-B data flow shown; B-to-A flow control is the same, except using \overline{xCEBA} , \overline{xLEBA} and \overline{xOEBA} .
- Before \overline{xLEAB} LOW-to-HIGH Transition

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

Operating Condition: TA = -40°C to +85°C

Symbol	Parameter	Test Conditions		Min.	Typ. ⁽¹⁾	Max.	Unit
VIH	Input HIGH Voltage Level	VCC = 2.3V to 2.7V		1.7	—	—	V
		VCC = 2.7V to 3.6V		2	—	—	
VIL	Input LOW Voltage Level	VCC = 2.3V to 2.7V		—	—	0.7	V
		VCC = 2.7V to 3.6V		—	—	0.8	
IIH IIL	Input Leakage Current	VCC = 3.6V	VI = 0 to 5.5V	—	—	±5	µA
IOZH IOZL	High Impedance Output Current (3-State Output pins)	VCC = 3.6V	VO = 0 to 5.5V	—	—	±10	µA
IOFF	Input/Output Power Off Leakage	VCC = 0V, VIN or VO ≤ 5.5V		—	—	±50	µA
VIK	Clamp Diode Voltage	VCC = 2.3V, IIN = -18mA		—	-0.7	-1.2	V
VH	Input Hysteresis	VCC = 3.3V		—	100	—	mV
ICCL ICCH IC CZ	Quiescent Power Supply Current	VCC = 3.6V	VIN = GND or VCC	—	—	10	µA
			3.6 ≤ VIN ≤ 5.5V ⁽²⁾	—	—	10	
ΔICC	Quiescent Power Supply Current Variation	One input at VCC - 0.6V other inputs at VCC or GND		—	—	500	µA

LVC Link

NOTES:

1. Typical values are at VCC = 3.3V, +25°C ambient.
2. This applies in the disabled state only.

BUS-HOLD CHARACTERISTICS

Symbol	Parameter ⁽¹⁾	Test Conditions		Min.	Typ. ⁽²⁾	Max.	Unit
IBHH IBHL	Bus-Hold Input Sustain Current	VCC = 3.0V	VI = 2.0V	-75	—	—	µA
			VI = 0.8V	75	—	—	
IBHH IBHL	Bus-Hold Input Sustain Current	VCC = 2.3V	VI = 1.7V	—	—	—	µA
			VI = 0.7V	—	—	—	
IBHHO IBHLO	Bus-Hold Input Overdrive Current	VCC = 3.6V	VI = 0 to 3.6V	—	—	±500	µA

LVC Link

NOTES:

1. Pins with Bus-hold are identified in the pin description.
2. Typical values are at VCC = 3.3V, +25°C ambient.

OUTPUT DRIVE CHARACTERISTICS

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Max.	Unit
VOH	Output HIGH Voltage	V _{CC} = 2.3V to 3.6V	I _{OH} = -0.1mA	V _{CC} - 0.2	—	V
		V _{CC} = 2.3V	I _{OH} = -6mA	2	—	
		V _{CC} = 2.3V	I _{OH} = -12mA	1.7	—	
		V _{CC} = 2.7V		2.2	—	
		V _{CC} = 3.0V		2.4	—	
		V _{CC} = 3.0V	I _{OH} = -24mA	2.2	—	
VOL	Output LOW Voltage	V _{CC} = 2.3V to 3.6V	I _{OL} = 0.1mA	—	0.2	V
		V _{CC} = 2.3V	I _{OL} = 6mA	—	0.4	
			I _{OL} = 12mA	—	0.7	
		V _{CC} = 2.7V	I _{OL} = 12mA	—	0.4	
		V _{CC} = 3.0V	I _{OL} = 24mA	—	0.55	

LVC Link

NOTE:

- V_{IH} and V_{IL} must be within the min. or max. range shown in the DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE table for the appropriate V_{CC} range. T_A = -40°C to +85°C.

OPERATING CHARACTERISTICS, V_{CC} = 3.3V ± 0.3V, T_A = 25°C

Symbol	Parameter	Test Conditions	Typical	Unit
CPD	Power Dissipation Capacitance per Transceiver Outputs enabled	C _L = 0pF, f = 10MHz	44	pF
CPD	Power Dissipation Capacitance per Transceiver Outputs disabled		4	pF

SWITCHING CHARACTERISTICS (1)

Symbol	Parameter	V _{CC} = 2.7V		V _{CC} = 3.3V ± 0.3V		Unit
		Min.	Max.	Min.	Max.	
t _{PLH} t _{PHL}	Propagation Delay Transparent Mode xAx to xBx or xBx to xAx	—	6.1	1.2	5.4	ns
t _{PLH} t _{PHL}	Propagation Delay xLEB _A to xAx, xLEAB to xBx	—	7.4	1.5	6.1	ns
t _{PZH} t _{PZL}	Output Enable Time xCEB _A or xCEAB to xAx or xBx	—	7.9	1.2	6.6	ns
t _{PZH} t _{PZL}	Output Enable Time xOE _B A or xOEAB to xAx or xBx	—	7.6	1	6.3	ns
t _{PHZ} t _{PLZ}	Output Disable Time xCEB _A or xCEAB to xAx or xBx	—	7.1	1.5	6.6	ns
t _{PHZ} t _{PLZ}	Output Disable Time xOE _B A or xOEAB to xAx or xBx	—	6.9	1.5	6.3	ns
t _{SU}	Set-up Time, data before $\overline{CE}\uparrow$	1.1	—	1.1	—	ns
t _{SU}	Set-up Time, data before $\overline{LE}\uparrow$, \overline{CE} LOW	1.1	—	1.1	—	ns
t _H	Hold Time, data after $\overline{CE}\uparrow$	1.9	—	1.9	—	ns
t _H	Hold Time, data after $\overline{LE}\uparrow$, \overline{CE} LOW	1.9	—	1.9	—	ns
t _w	Pulse Width LOW xLEB _A or xLEAB, xCEB _A or xCEAB	3.3	—	3.3	—	ns
t _{sk(o)}	Output Skew ⁽²⁾	—	—	—	500	ps

NOTES:

- See test circuits and waveforms. T_A = -40°C to +85°C.
- Skew between any two outputs of the same package and switching in the same direction.

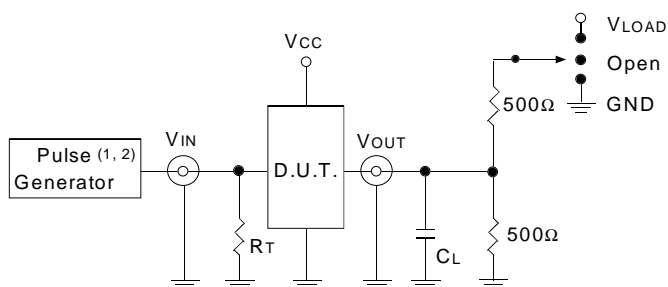
TEST CIRCUITS AND WAVEFORMS

TEST CONDITIONS

Symbol	V _{CC} (1) = 3.3V ± 0.3V	V _{CC} (1) = 2.7V	V _{CC} (2) = 2.5V ± 0.2V	Unit
V _{LOAD}	6	6	2 x V _{CC}	V
V _{IH}	2.7	2.7	V _{CC}	V
V _T	1.5	1.5	V _{CC} / 2	V
V _{LZ}	300	300	150	mV
V _{HZ}	300	300	150	mV
C _L	50	50	30	pF

LVC Link

TEST CIRCUITS FOR ALL OUTPUTS



LVC Link

DEFINITIONS:

C_L = Load capacitance: includes jig and probe capacitance.
R_T = Termination resistance: should be equal to Z_{OUT} of the Pulse Generator.

NOTE:

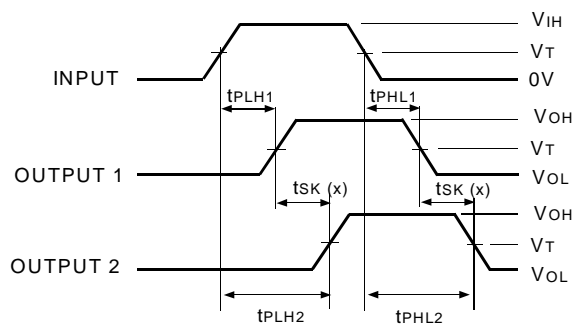
1. Pulse Generator for All Pulses: Rate ≤ 10MHz; t_F ≤ 2.5ns; t_R ≤ 2.5ns.
2. Pulse Generator for All Pulses: Rate ≤ 10MHz; t_F ≤ 2ns; t_R ≤ 2ns.

SWITCH POSITION

Test	Switch
Open Drain Disable Low Enable Low	V _{LOAD}
Disable High Enable High	GND
All Other tests	Open

LVC Link

OUTPUT SKEW - t_{SK}(x)



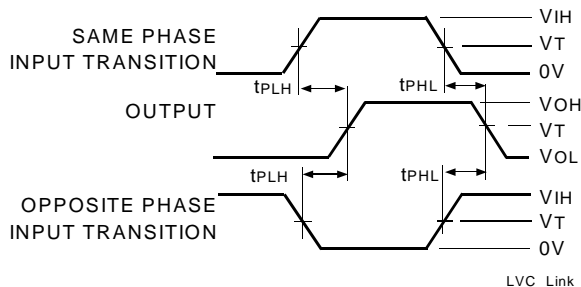
$$t_{SK}(x) = |t_{PLH2} - t_{PLH1}| \text{ or } |t_{PHL2} - t_{PHL1}|$$

NOTES:

1. For t_{SK}(a) OUTPUT1 and OUTPUT2 are any two outputs.
2. For t_{SK}(b) OUTPUT1 and OUTPUT2 are in the same bank.

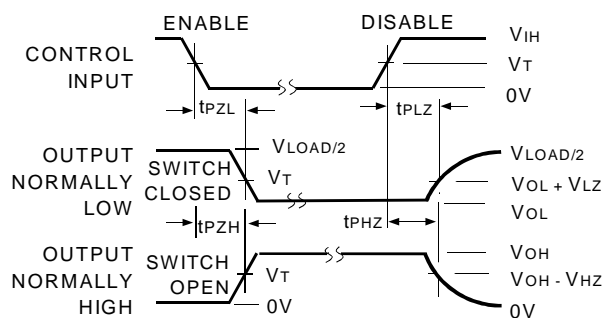
LVC Link

PROPAGATION DELAY



LVC Link

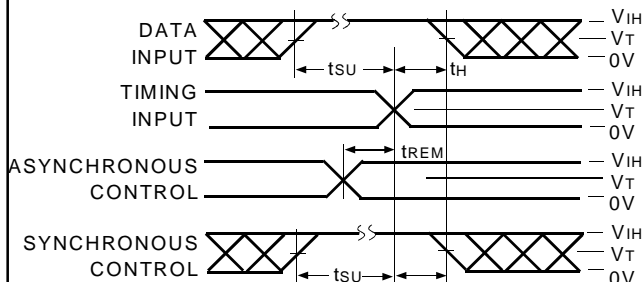
ENABLE AND DISABLE TIMES



NOTE:

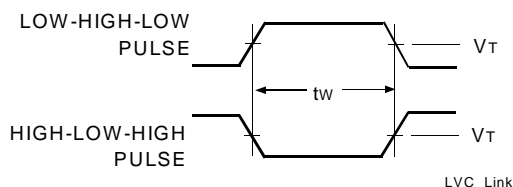
1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.

SET-UP, HOLD, AND RELEASE TIMES



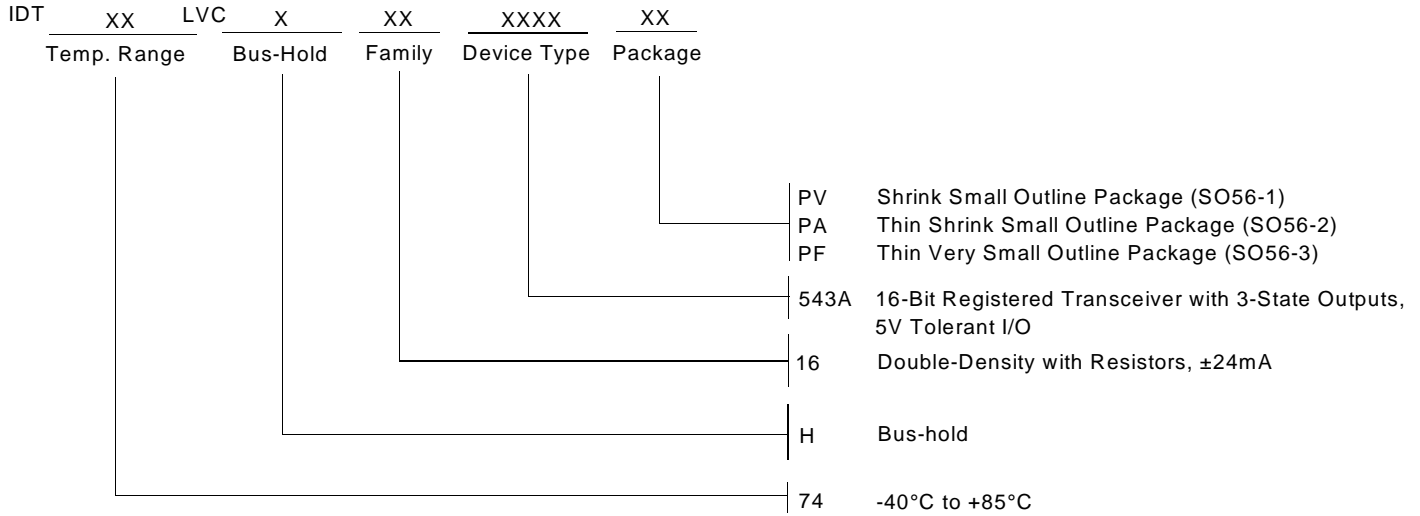
LVC Link

PULSE WIDTH



LVC Link

ORDERING INFORMATION



CORPORATE HEADQUARTERS
 2975 Stender Way
 Santa Clara, CA 95054

for SALES:
 800-345-7015 or 408-727-6116
 fax: 408-492-8674
 www.idt.com*

*To search for sales office near you, please click the sales button found on our home page or dial the 800# above and press 2.
 The IDT logo is a registered trademark of Integrated Device Technology, Inc.